	Hits	Search Text	DBs	Time Stamp
1	5	(circuit and stress and dynes).clm.	US-PGPUB	2008/01/22 00:37
2	96	(circuit and stress and membrane).clm.	US-PGPUB	2008/01/22 00:37
3	5	(circuit and stress with dynes and membrane).clm.	US-PGPUB	2008/01/22 00:37
4	9	(source with drain with gate and stress and membrane).clm.	US-PGPUB	2008/01/22 00:38
5	1	(source with drain with gate and stress and dynes).clm.	US-PGPUB	2008/01/22 00:38
6	1	(source with drain with gate and stress with dynes).clm.	US-PGPUB	2008/01/22 00:38
7	0	(source with drain with gate and stress with dynes and membrane).clm.	US-PGPUB	2008/01/22 00:39
8	23	(interconnect and stress and membrane).clm.	US-PGPUB	2008/01/22 00:39
9	6	(interconnect and stress with dynes and membrane).clm.	US-PGPUB	2008/01/22 00:39
10	1	(data adj sink and stress and membrane).clm.	US-PGPUB	2008/01/22 00:40
11	1	(data adj sink and stress with dynes and membrane).clm.	US-PGPUB	2008/01/22
12	4	(circuit and stress with dynes and substrate with (remov\$3 etch\$3)).clm.	US-PGPUB	2008/01/22 00:41
13	160	<pre>(circuit and stress and substrate with (remov\$3 etch\$3)).clm.</pre>	US-PGPUB	2008/01/22